

Revision History

AS7C34096B 512K X 8 BIT HIGH SPEED CMOS SRAM

Revision	Details	Date
Rev 1.0	Initial Issue	Aug. 2016
Rev 1.1	Added 6mm x 8mm TFBGA Package	Sep. 2017



FEATURES

Fast access time : 10nsLow power consumption:

Operating current: 40mA(TYP.) Standby current: 2mA(TYP.)

■ Single 3.3V power supply

■ All inputs and outputs TTL compatible

■ Fully static operation

■ Tri-state output

Data retention voltage : 1.5V (MIN.)
Package : 44-pin 400 mil TSOP-II
36-ball 6mm x 8mm TFBGA

GENERAL DESCRIPTION

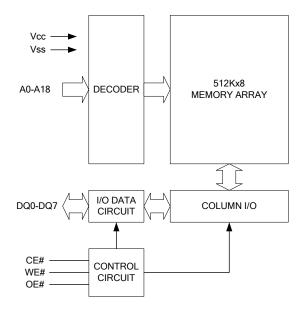
The AS7C34096B is a 4,194,304-bit high speed CMOS static random access memory organized as 524,288 words by 8 bits. It is fabricated using very high performance, high reliability CMOS technology. Its standby current is stable within the range of operating temperature.

The AS7C34096B operates from a single power supply of 3.3V and all inputs and outputs are fully TTL compatible

Table 1. Ordering Information

Part Number Speed		Temperature	Vcc Range	Package
AS7C34096B-10TIN	10ns	Industrial -40°C to +85°C	2.7 ~ 3.6V	44pin TSOPII
AS7C34096B-10BIN	10ns	Industrial -40°C to +85°C	2.7 ~ 3.6V	36ball FBGA

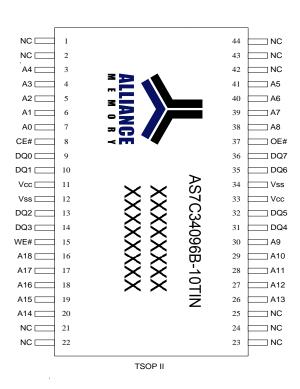
FUNCTIONAL BLOCK DIAGRAM

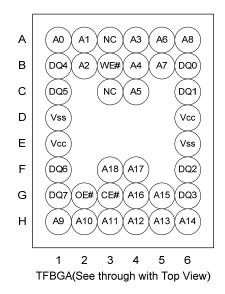


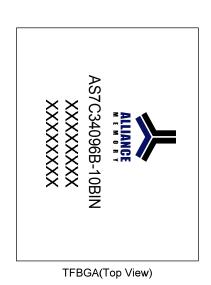
PIN DESCRIPTION

SYMBOL	DESCRIPTION
A0 - A18	Address Inputs
DQ0 – D7	Data Inputs/Outputs
CE#	Chip Enable Inputs
WE#	Write Enable Input
OE#	Output Enable Input
Vcc	Power Supply
V _{SS}	Ground
NC	No Connection

PIN CONFIGURATION







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ABSOLUTE MAXIMUM RATINGS*

PARAMETER	SYMBOL	RATING	UNIT
Voltage on V_{CC} relative to V_{SS}	V_{T1}	-0.5 to 4.6	V
Voltage on any other pin relative to V _{SS}	V_{T2}	-0.5 to Vcc+0.5	V
Operating Temperature	TA	-40 to 85	$^{\circ}\mathbb{C}$
Storage Temperature	T _{STG}	-65 to 150	$^{\circ}\mathbb{C}$
Power Dissipation	PD	1	W
DC Output Current	Іоит	50	mA

^{*}Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

TRUTH TABLE

MODE	CE#	OE#	WE#	I/O OPERATION	SUPPLY CURRENT
Standby	Н	X	Х	High-Z	IsB,IsB1
Output Disable	L	Н	Н	High-Z	Icc,Icc1
Read	L	L	Н	D _{оит}	Icc,Icc1
Write	L	Х	L	Din	Icc,Icc1

Note: $H = V_{IH}$, $L = V_{IL}$, X = Don't care.

DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP. *4	MAX.	UNIT
Supply Voltage	Vcc		2.7	3.3	3.6	V
Input High Voltage	V _{IH} *1		2.2	-	V _{CC} +0.3	V
Input Low Voltage	V _{IL} *2		- 0.3	-	0.8	V
Input Leakage Current	ILI	$V_{CC} \ge V_{IN} \ge V_{SS}$	- 1	-	1	μA
Output Leakage Current	ILO	$V_{CC} \ge V_{OUT} \ge V_{SS},$ Output Disabled	- 1	-	1	μA
Output High Voltage	Vон	I _{OH} = -4mA	2.4	-	-	V
Output Low Voltage	Vol	I _{OL} = 8mA	-	-	0.4	V
Average Operating Power Supply Current	Icc	Cycle time = Min. CE# = V _{IL} , I _{I/O} = 0mA, Others at V _{IL} or V _{IH}	-	50	70	mA
	Icc1	CE# \leq 0.2, Others at 0.2V or Vcc-0.2V I _{I/O} = 0mA;f=max	-	40	55	mA
Standby Power	I _{SB}	CE# =V _{IH} , Others at V _{IL} or V _{IH}	-	-	30	mA
Supply Current	I _{SB1}	CE# \geq V _{CC} - 0.2V, Others at 0.2V or V _{CC} - 0.2V	-	2	10	mA

Notes:

^{1.} $V_{IH(max)} = V_{CC} + 2.0V$ for pulse width less than 6ns.

^{2.} $V_{\text{IL}(min)}$ = V_{SS} - 2.0V for pulse width less than 6ns.

^{3.} Over/Undershoot specifications are characterized on engineering evaluation stage, not for mass production test.

^{4.} Typical values are included for reference only and are not guaranteed or tested. Typical valued are measured at V_{CC} = V_{CC}(TYP.) and T_A = 25°C

CAPACITANCE (TA = 25°C, f = 1.0MHz)

PARAMETER	SYMBOL	MIN.	MAX	UNIT
Input Capacitance	Cin	-	8	pF
Input/Output Capacitance	Cı/o	-	10	pF

Note: These parameters are guaranteed by device characterization, but not production tested.

AC TEST CONDITIONS

Speed	10ns
Input Pulse Levels	0.2V to Vcc - 0.2V
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	$C_L = 30pF + 1TTL$, $I_{OH}/I_{OL} = -4mA/8mA$

AC ELECTRICAL CHARACTERISTICS

(1) READ CYCLE

PARAMETER	SYM.	AS7C34	096B-10	UNIT
PARAMETER	STIVI.	MIN.	MAX.	ONII
,	trc	10	-	ns
Address Access Time	taa	-	10	ns
-	t ace	-	10	ns
	toe	-	4.5	ns
l ·	tclz*	2	-	ns
Output Enable to Output in Low-Z	tolz*	0	-	ns
1 1	tcHz*	-	4	ns
Output Disable to Output in High-Z		-	4	ns
Output Hold from Address Change	tон	2	-	ns

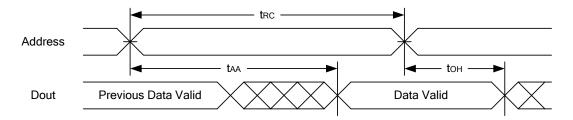
(2) WRITE CYCLE

PARAMETER	SYM.	AS7C34	096B-10	UNIT
	STW.	MIN.	MAX.	ONT
Write Cycle Time	twc	10	-	ns
Address Valid to End of Write	taw	8	-	ns
Chip Enable to End of Write	tcw	8	-	ns
Address Set-up Time	tas	0	-	ns
Write Pulse Width	twp	8	-	ns
Write Recovery Time	twr	0	-	ns
Data to Write Time Overlap	tow	6	-	ns
Data Hold from End of Write Time	tон	0	-	ns
Output Active from End of Write	tow*	2	-	ns
Write to Output in High-Z	twnz*	-	4	ns

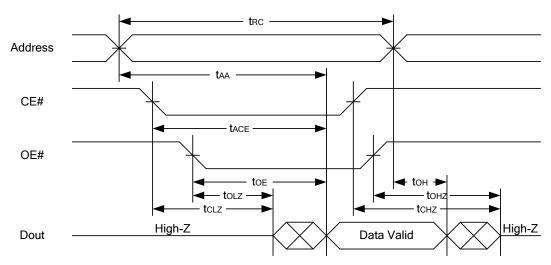
^{*}These parameters are guaranteed by device characterization, but not production tested.

TIMING WAVEFORMS

READ CYCLE 1 (Address Controlled) (1,2)



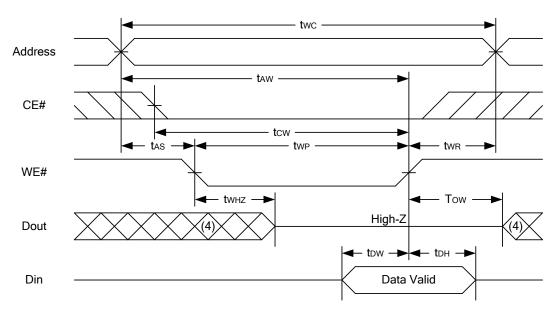
READ CYCLE 2 (CE# and OE# Controlled) (1,3,4,5)



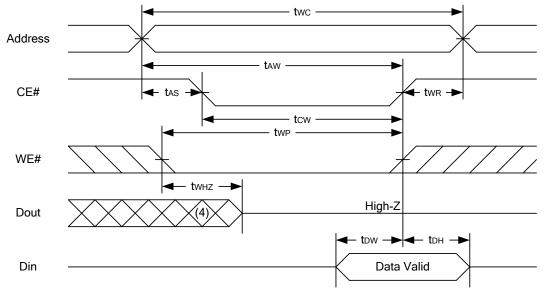
Notes

- 1.WE# is high for read cycle.
- 2.Device is continuously selected OE# = low, CE# = low.
- 3.Address must be valid prior to or coincident with CE# = low,; otherwise tAA is the limiting parameter.
- 4.t_{CLZ}, t_{OLZ}, t_{CHZ} and t_{OHZ} are specified with C_L = 5pF. Transition is measured ±500mV from steady state.
- 5.At any given temperature and voltage condition, t_{CHZ} is less than t_{CLZ} , t_{OHZ} is less than t_{CLZ}

WRITE CYCLE 1 (WE# Controlled) (1,2,4,5)



WRITE CYCLE 2 (CE# Controlled) (1,4,5)



Notes:

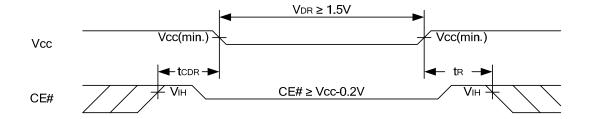
- 1.A write occurs during the overlap of a low CE#, low WE#.
- 2.During a WE# controlled write cycle with OE# low, twp must be greater than twHZ + tDw to allow the drivers to turn off and data to be placed on the bus.
- 3. During this period, I/O pins are in the output state, and input signals must not be applied.
- 4.If the CE# low transition occurs simultaneously with or after WE# low transition, the outputs remain in a high impedance state.
- 5.tow and twHz are specified with C_L = 5pF. Transition is measured ± 500 mV from steady state.

DATA RETENTION CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Vcc for Data Retention	V _{DR}	$CE\# \ge V_{CC} - 0.2V$	1.5	-	3.6	V
Data Retention Current	I _{DR}	V_{CC} = 1.5V $CE\# \ge V_{CC}$ - 0.2V Others at 0.2V or V_{cc} - 0.2V	-	2	10	mA
Chip Disable to Data Retention Time	tcdr	See Data Retention Waveforms (below)	0	-	-	ns
Recovery Time	t _R		t _{RC*}	-	-	ns

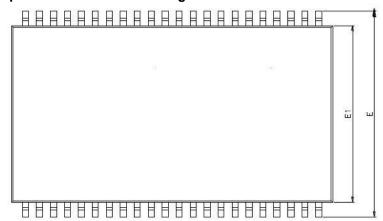
t_{RC*} = Read Cycle Time

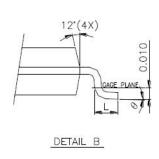
DATA RETENTION WAVEFORM

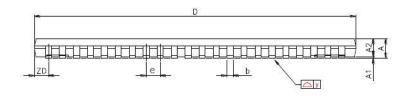


PACKAGE OUTLINE DIMENSION

44-pin 400mil TSOP-II Package Outline Dimension





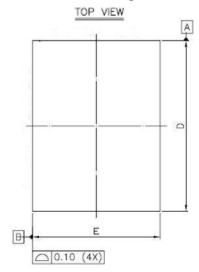


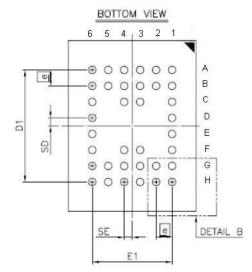


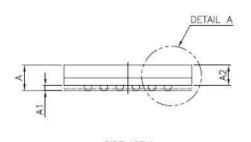
SYMBOLS	DIMENSI	ONS IN MILL	METERS	DIMI	ENSIONS IN I	MILS
STWIBULS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	-	-	1.20	-	-	47.2
A1	0.05	0.10	0.15	2.0	3.9	5.9
A2	0.95	1.00	1.05	37.4	39.4	41.3
b	0.30	-	0.45	11.8	-	17.7
С	0.12	-	0.21	4.7	-	8.3
D	18.212	18.415	18.618	717	725	733
E	11.506	11.760	12.014	453	463	473
E1	9.957	10.160	10.363	392	400	408
е	-	0.800	-	-	31.5	-
L	0.40	0.50	0.60	15.7	19.7	23.6
ZD	-	0.805	-	-	31.7	-
У	-	-	0.076	-	-	3
θ	0°	3°	6°	0°	3°	6°

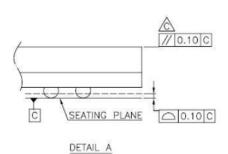


36 ball 6mm × 8mm TFBGA Package Outline Dimension

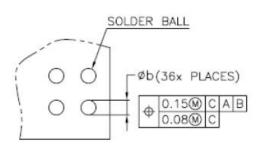












DETAIL B

	CVM	DIMENSION (mm)			DIMENSION (inch)		
	SYM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
	Α	_	_	1.20	_	_	0.047
	A1	0.20	0.25	0.30	0.008	0.010	0.012
	A2	_	_	0.94	_	_	0.037
	b	0.30	0.35	0.40	0.012	0.014	0.016
B	D	7.95	8.00	8.05	0.313	0.315	0.317
	D1	5.25 BSC			0.207 BSC		
B	Ε	5.95	6.00	6.05	0.234	0.236	0.238
	E1	3	.75 BS0	0	0.148 BSC		
	SE	0	.375 TY	P	0.015 TYP		
	SD	0	.375 TY	P	0.015 TYP		
	e	0.75 BSC			0.030 BSC		

NOTE:

CONTROLLING DIMENSION: MILLIMETER.
REFERENCE DOCUMENT: JEDEC MO-207.

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PART NUMBERING SYSTEM

AS7C	34096B	10	T/B	I	N
SRAM	34096=512k x 8 B=B die	10=10ns	T = TSOPII B=TFBGA	I=Industrial (-40° C~+85° C)	Indicates Pb and Halogen Free



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